Supporting Information

Integration of Photovoltaic and Photogating Effects in WSe₂/WS₂/p-Si Dual Junction Photodetector Featuring High-Sensitivity and Fast-Response

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Supplementary Notes

Note S1: Calculation of surface potential difference (SPD):

The SPD between the AFM tip, WSe₂, WS₂ and p-Si can be calculated as follow:

$$eSPD_{WSe2} = \Phi_{WSe2} - \Phi_{tip}$$
(1)

$$eSPD_{WS2} = \Phi_{WS2} - \Phi_{tip}$$
(2)

$$eSPD_{p-Si} = \Phi_{p-Si} - \Phi_{tip}$$
(3)

where Φ_{WSe2} , Φ_{WS2} , Φ_{p-Si} and Φ_{tip} are the work functions WSe₂, WS₂, p-Si and the AFM tip, respectively.^[1-2] Thus, the Fermi level difference (ΔE_{f1}) between WS₂ and WSe₂ can be obtained by

$$\Delta E_{f1} = \Phi_{WS2} - \Phi_{WSe2} = eSPD_{WS2} - eSPD_{WSe2}$$
(4)

Similarly, the Fermi level difference (ΔE_{f2}) between WS₂ and p-Si can be obtained by

$$\Delta E_{f2} = \Phi_{WS2} - \Phi_{Si} = eSPD_{WS2} - eSPD_{p-Si}$$
(5)

Note S2: Calculation of the key figures-of-merit for photodetectors

The important parameters that need to be calculated to better evaluate the optoelectronic performance of WSe₂/WS₂/p-Si device include responsivity (R), detectivity (D*), light on/off ratio (I_{on}/I_{off}), photoconductive gain (gain), and response time (τ_{rise} and τ_{decay}). The appeal parameters are computed by the following public statements: ^[3-5]

$$R = \frac{I_{ph}}{PS} = \frac{I_{light} - I_{dark}}{PS}$$
(6)

$$D^* = \frac{RS^{1/2}}{(2qI_{dark})^{1/2}}$$
(7)

$$I_{on} / I_{off} = \frac{I_{ph}}{I_{dark}}$$
(8)

$$Gain = \frac{\tau_t}{\tau_{transit}} = {\binom{l_p/e}{}} / {\binom{PS/hv}{}} = hcR/(q\lambda)$$
(9)

where the electronic charge is defined as q, the effective sensing area is defined as S, the incident light density is defined as P, the Planck constant ($6.626 \times 10^{-34} \text{ J s}^{-1}$) is defined as h, light velocity is defined as c, the wavelength of the incident light is defined as λ , the photocurrent ($I_{ph} = I_{light} - I_{dark}$) is defined as I_{ph} , the device currents in light and darkness are I_{light} and I_{dark} , respectively.

Rise time (τ_{rise}) and decay time (τ_{decay}) are determined as the time elapsed between 10%/90% and 90%/10% of the pure photocurrent.^[6]

Note S3: First-Principle Calculations

The theoretically results were based on the general gradient approximation (GGA) of Perdew, Burke and Ernzerhof (PBE), with the projector augmented plane-wave method in the Vienna Ab-initio Simulation Package (VASP) code.^[7-11] The initial structure of three materials (monolayer WS₂, monolayer WSe₂ and bulk Si), set a vacuum larger than 15 Å around the slab for eliminating the interaction, built in Materials studio. All the atomic coordinates were fully relaxed with the force tolerance on 0.02 eV Å. The total energies calculation was set a plane-wave cutoff at 450 eV and a $15 \times 15 \times 1$ Γ -center k-point grid. The electron density projection of the VBM (valence band maximum) and CBM (conduction band minimum) of the heterojunction material on the real space is calculated by the band decomposed charge densities method. The detailed calculation steps of this method can be obtained from the VASP manual.

Supplementary Figures



Figure S1. (a) Low-resolution TEM image of the WSe₂ flake. (b-c) Elemental distribution maps in the WSe₂ flake. (d) Low-resolution TEM image of the WS₂ flake. (e-f) Elemental distribution maps in the WS₂ flake.



Figure S2. Raman spectra of the WSe_2 , WS_2 and HDH heterostructures.



Figure S3. Spectral photocurrent of the (a) WS_2 and (b) WSe_2 devices at the range of 400–1100 nm. The WS_2 shows a photoresponse peak at 630 nm, and the WSe_2 shows two photoresponse peaks at 668 nm and 759 nm.



Figure S4. Spectral photocurrent of the commercial Si device (S120VC, Thorlabs) at the range of 400–1100 nm. The responsivity is less than 45 mA/W, and the

photoresponse peak is 965 nm.



Figure S5. Structures and electrical connections of the constructed devices. (a) HDH device, where WS_2 is contacted with the drain and WSe_2 is contact with the source. (b) WSe_2/p -Si device, where WSe_2 is contact with the drain and p-Si is contact with the source. (c) WS_2/p -Si device, where WS_2 is contact with the drain and p-Si is contact with the source. *I-V* curves of the (d) HDH device, (e) WSe_2/p -Si device, and (f) WS_2/p -Si device under dark and illumination with various intensities. Photocurrent of the (g) HDH device, (h) WSe_2/p -Si device, and (i) WS_2/p -Si device as a function of illumination intensity at the bias of 0 V and 1 V.



Figure S6. (a) Optical image of the WS₂-WSe₂ device. The WSe₂ and WS₂ flakes are marked in blue and red dashed lines, respectively. Source and drain are connected to the WSe₂ and WS₂, respectively. (b) *I-V* curves of the device in the dark and under 405 nm light irradiation with different powers. (c) Response time of the device at a voltage of -1 V. The corresponding τ_{rise} and τ_{decay} are 6.839 ms and 5.427 ms, respectively.



Figure S7. (a) Optical image of the WS_2 device. (b) *I-V* curve of the WS_2 device in the dark. The device shows linear *I-V* curve in the dark, indicating ohmic contact between the Ti/Au electrodes and WS_2 .



Figure S8. (a) Optical image of the WSe₂ device. (b) I-V curve of the WSe₂ device in the dark. The device shows linear I-V curve in the dark, indicating ohmic contact between the Au electrodes and WSe₂.



Figure S9. The calculated (a) R, (b) detectivity (D*), (c) Gain, and (d) light on/off ratio (I_{on}/I_{off}) of the HDH device as a function of illumination intensity at the bias of -1 V, 0 V, and 1 V.



Figure S10. Photoswitching characteristics of the HDH device under pulsed 405 nm light for more than 500 cycles.



Figure S11. Schematic diagram of the energy band structures of $WSe_2/WS_2/p$ -Si after contact. E_1 and E_2 are the built-in electric fields.

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